507026255 12/14/2021

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT7073090

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date	
JONG HYUK PARK	11/11/2021	

RECEIVING PARTY DATA

Name:	HYUNDAI MOBIS CO., LTD.	
Street Address:	203, TEHERAN-RO, GANGNAM-GU	
City:	SEOUL	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	06141	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17550446

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 12025599159

Email: docketing@novotechip.com

Correspondent Name: NOVOTECHIP INTERNATIONAL PLLC Address Line 1: 1717 PENNSYLVANIA AVENUE NW

Address Line 4: WASHINGTON, D.C. 20006

ATTORNEY DOCKET NUMBER:	031421-028
NAME OF SUBMITTER:	WONSUCK CHOI
SIGNATURE:	/Wonsuck Choi/
DATE SIGNED:	12/14/2021

Total Attachments: 2

source=20211214_031421-028_Assignment#page1.tif source=20211214_031421-028_Assignment#page2.tif

PATENT 507026255 REEL: 058386 FRAME: 0439

NovoTechIP Docket No. 031421-028

ASSIGNMENT

WHEREAS, I, Jong Hyuk PARK ("Assignor") have made certain new and useful

inventions and improvements for which an application for Letters Patent of the United States

is filed concurrently herewith, and entitled "ADAPTIVE IMPEDANCE MATCHING

APPARATUS AND METHOD FOR WIRELESS POWER TRANSFER";

AND WHEREAS, HYUNDAI MOBIS CO., LTD., a Korean corporation having a

place of business at 203, Teheran-ro, Gangnam-gu, Seoul, 06141, Republic of Korea

(hereinafter "Assignee"), is desirous of acquiring the entire right, title and interest in and to

said inventions, improvements and application and in and to the Letters Patent to be obtained

therefore;

NOW, THEREFORE, to all whom it may concern, be it known that for good and

valuable consideration, the receipt and sufficiency whereof is hereby acknowledged by the

Assignor, the Assignor has sold, assigned, and transferred, and by these presents does hereby

sell, assign and transfer unto said Assignee, its successors or assigns, the entire right, title and

interest for all countries in and to all inventions and improvements disclosed in the aforesaid

application, and in and to the said application, all divisions, continuations, continuations-in-

part, or renewals thereof, all Letters Patent which may be granted there from, and all reissues

or extensions of such patents, and in and to any and all applications which have been or shall

be filed in any foreign countries for Letters Patent on the said inventions and improvements,

including an assignment of all rights under the provisions of the International Convention, and

all Letters Patent of foreign countries which may be granted there from; and Assignor does

hereby authorize and request the Commissioner of Patents and Trademarks to issue any and all

United States Letters Patent for the aforesaid inventions and improvements to the said Assignee

as the assignee of the entire right, title and interest in and to the same, for the use of the said

Assignee, its successors and assigns;

AND, for the consideration aforesaid, the Assignor does hereby agree that he and his

executors and legal representatives will make, execute and deliver any and all other instruments

in writing including any and all further application papers, affidavits, assignments and other

documents, and will communicate to said Assignee, its successors and representatives all facts

known to the Assignor relating to said improvements and the history thereof and at no cost to

1 of 2

PATENT REEL: 058386 FRAME: 0440

NovoTechIP Docket No. 031421-028

Assignor will testify in all legal proceedings and generally do all things which may be

necessary or desirable more effectually to secure to and vest in said Assignee, its successors or

assigns the entire right, title and interest in and to the said improvements, inventions,

applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold,

assigned and conveyed, or intended so to be;

AND, furthermore, the Assignor covenants and agrees with said Assignee, its

successors and assigns, that no assignment, grant, mortgage, license or other agreement

affecting the rights and property herein conveyed has been made to others by the Assignor and

that full right to convey the same as herein expressed is possessed by the Assignor;

AND, furthermore, the Assignor hereby agrees that this Assignment may be executed

in two or more counterparts each of which shall be deemed an original but all of which together

shall constitute one and the same instrument.

IN TESTIMONY WHEREOF, the Assignor has hereunto set his hand:

Name:	Jong Hyuk PARK	Date:	2021.	11.11.	
Signature:	4 % %				

2 of 2

PATENT REEL: 058386 FRAME: 0441

RECORDED: 12/14/2021